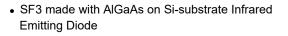
AM2520SF3C03-100MAV

Infrared Emitting Diode



PACKAGE DIMENSIONS



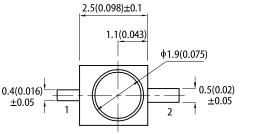
FEATURES

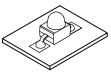
DESCRIPTION

- Subminiature package
- · Mechanically and spectrally matched to the Phototransistor
- · High radiant power and high speed
- Package matches with photodetector AM2520PD1BT03
- · Gull wing lead
- · Long life solid state reliability
- · Low package profile
- Package: 1000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

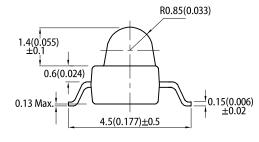
APPLICATIONS

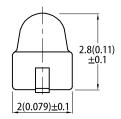
- · Infrared Illumination for cameras
- Machine vision systems
- Surveillance systems
- Industrial electronics
- · IR data transmission
- Remote control





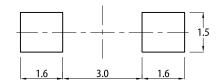






RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes

Notes:
 All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Dout Number	Emitting Color		Po (mW/sr) @ 100mA ^[2]		Viewing Angle ^[1]
Part Number	(Material)		Min.	Тур.	201/2
AM2520SF3C03-100MAV	Infrared (AlGaAs)	Water Clear	80	120	20°

Notes

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Radiant Intensity / luminous flux: +/-15%.
 3. Radiant intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol Emitting Color Typ.	Emitting Color	Value		Unit
Faldmeter		Тур.	Max.		
Wavelength at Peak Emission I_F = 100mA	λ_{peak}	Infrared	940	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 100mA	Δλ	Infrared	48	-	nm
Forward Voltage I _F = 100mA	V _F ^[1]	Infrared	1.55	1.8	V
Reverse Current (V _R = 5V)	I _R	Infrared	-	10	μΑ
Rise Time I _F = 100mA	t _r	Infrared	10.6	-	ns
Fall Time I _F = 100mA	t _f	Infrared	10.3	-	ns
Temperature Coefficient of Wavelength I_F = 100mA, -10°C \leq T \leq 85°C	TC _λ	Infrared	0.3	-	nm/°C
Temperature Coefficient of V_F I_F = 100mA, -10°C $\leq T \leq 85°$ C	TCv	Infrared	-1.4	-	mV/°C

Notes:

Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

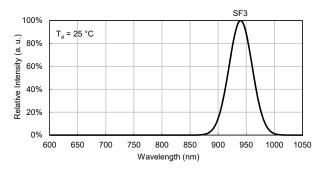
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	180	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	100	mA
Peak Forward Current	Ι _{FP} ^[1]	1200	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	250	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	180	°C/W

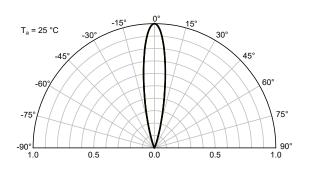
Notes: 1. 1/100 Duty Cycle, 10µs Pulse Width. 2. R_{h_1,h_2} , R_{h_1,h_2} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

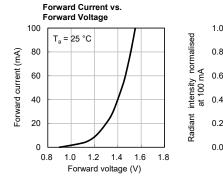
RELATIVE INTENSITY vs. WAVELENGTH

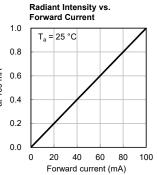


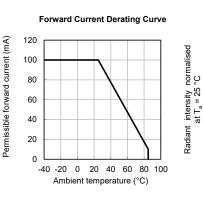
SPATIAL DISTRIBUTION



INFRARED



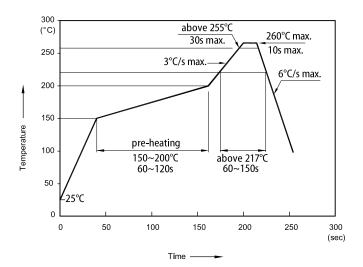




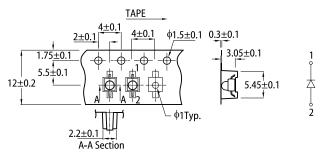
Radiant Intensity vs. Ambient Temperature 2.5 2.0 1.5 1.0 0.5 0.0

-40 -20 0 20 40 60 80 100 Ambient temperature (°C)

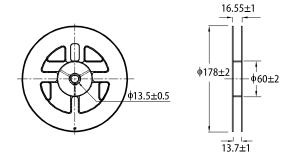
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

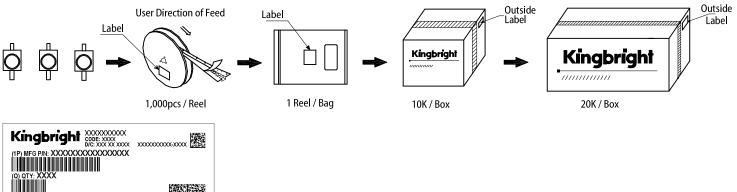
DE: XXXX

(4L) COO: CN

1

AM2520SF3C03-100MAV

PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. 2
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- The contexts and information of this document may be be responsible to the product is being operated within the environmental and electrical limits specified in the datasiteet. In customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance. The contexts and information of this document may not be responduced or re-transmitted without permission by Kingbright. All design applications should refer to Kingbright application notes available at https://www.KingbrightUSA.com/ApplicationNotes 4.
- 5
- 6.